

SOT1196-1

SO12: plastic small outline package; 12 leads; body width 3.9 mm

8 February 2016

Package information

1. Package summary

Terminal position code	D (double)
Package type descriptive code	SO12
Package type industry code	SO12
Package style descriptive code	SO (small outline)
Package style suffix code	NA (not applicable)
Package body material type	P (plastic)
IEC package outline code	---
JEDEC package outline code	MS-012 Compliant
JEITA package outline code	---
Mounting method type	S (surface mount)
Issue date	16-2-2011

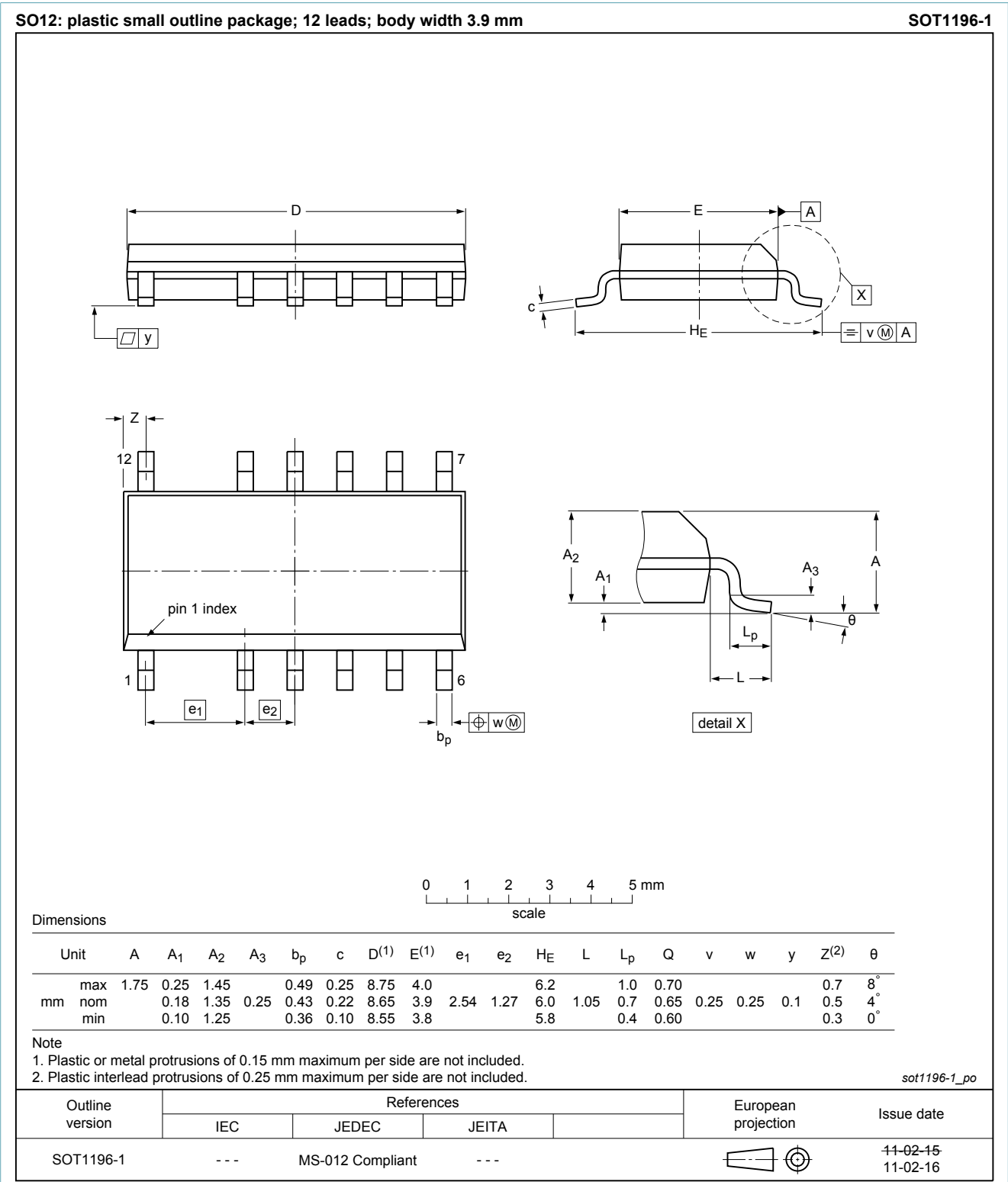
Table 1. Package summary

Symbol	Parameter		Min	Typ	Nom	Max	Unit
D	package length		8.55	-	8.65	8.75	mm
E	package width		3.8	-	3.9	4	mm
A	seated height		[tbd]	-	[tbd]	1.75	mm
A ₂	package height		1.25	-	1.35	1.45	mm
e	nominal pitch		-	-	1.27	-	mm
n ₂	actual quantity of termination		-	-	12	-	



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2. Package outline



3. Legal information

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